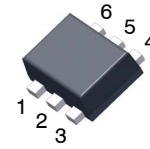


# MOSFET – N-Channel Enhancement Mode Field Effect Transistor

60 V, 0.28 A, 2 Ω

2N7002V/2N7002VA



SOT-563  
CASE 419BH

\*Pin 1 and Pin 4 are exchangeable.

## Features

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- This Device is Pb-Free, Halide Free and RoHS Compliant

## MOSFET MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V <sub>DSS</sub>	Drain – Source Voltage	60	V
V <sub>DGR</sub>	Gate – Gate Voltage (R <sub>GS</sub> ≤ 1.0 MΩ)	60	V
V <sub>GSS</sub>	Gate–Source Voltage	– Continuous	±20
		– Pulsed	±40
I <sub>D</sub>	Drain Current	– Continuous	280
		– Pulsed	1.5
T <sub>J</sub> , T <sub>STG</sub>	Junction and Storage Temperature Range	–55 to +150	°C

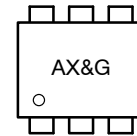
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
P <sub>D</sub>	Total Device Dissipation	250	mW
	Derate Above T <sub>A</sub> = 25°C	2.0	mW/°C
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1)	500	°C/W

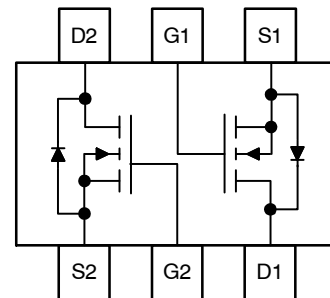
1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size.

## MARKING DIAGRAM

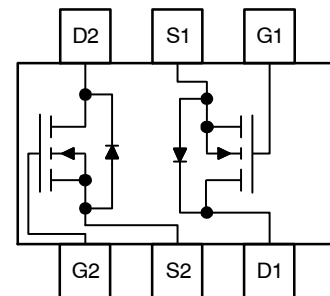


AX = Device Code (X = B or C)  
&G = 1-Digit Weekly Date Code

## PIN ASSIGNMENT



2N7002V



2N7002VA

## ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

## 2N7002V/2N7002VA

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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#### OFF CHARACTERISTICS

BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 10 μA	60	78	–	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V	–	0.001	1.0	μA
		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C		7	500	
I <sub>GSS</sub>	Gate–Body Leakage	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V	–	0.2	±100	nA

#### ON CHARACTERISTICS (Note 2)

V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.00	1.76	2.50	V
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	V <sub>GS</sub> = 5 V, I <sub>D</sub> = 0.05 A	–	1.6	7.5	Ω
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 A	–	–	2.0	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 A, T <sub>J</sub> = 125°C	–	2.53	13.5	
I <sub>D(on)</sub>	On–State Drain Current	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 7.5 V	1.50	1.43	–	A
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.2 A	80	356.5	–	mS

#### DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz	–	37.8	50	pF
C <sub>oss</sub>	Output Capacitance		–	12.4	25	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		–	6.5	7	pF

#### SWITCHING CHARACTERISTICS

t <sub>d(on)</sub>	Turn–On Delay Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 0.2 A, V <sub>GEN</sub> = 10 V, R <sub>L</sub> = 150 Ω, R <sub>GEN</sub> = 25 Ω	–	5.85	20	ns
t <sub>d(off)</sub>	Turn–Off Delay Time		–	12.5	20	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Short duration test pulse used to minimize self–heating effect.

TYPICAL PERFORMANCE CHARACTERISTICS

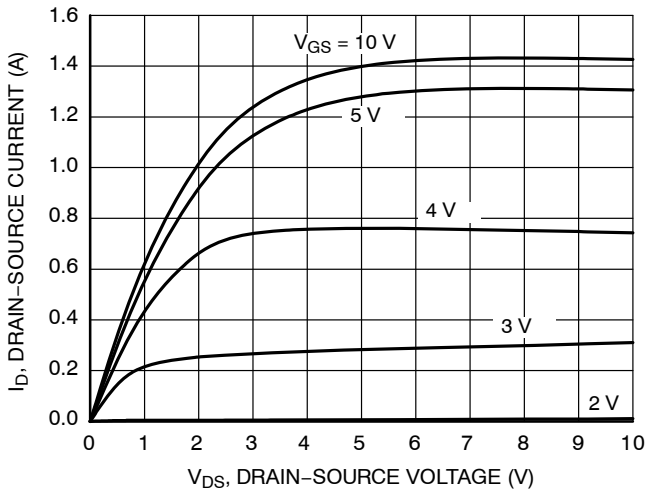


Figure 1. On - Region Characteristics

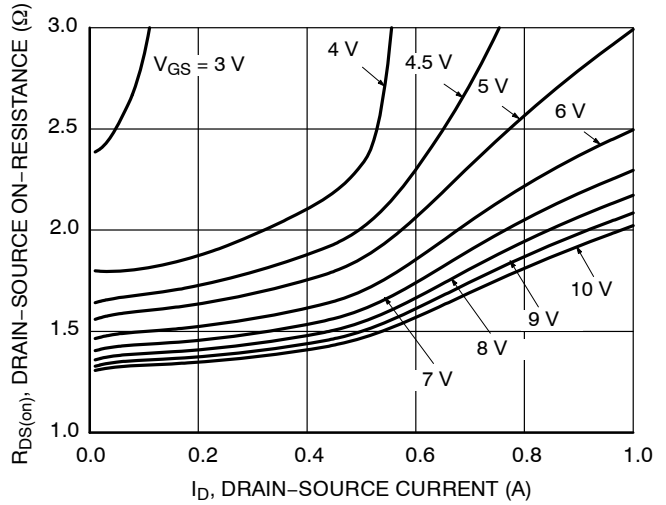


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

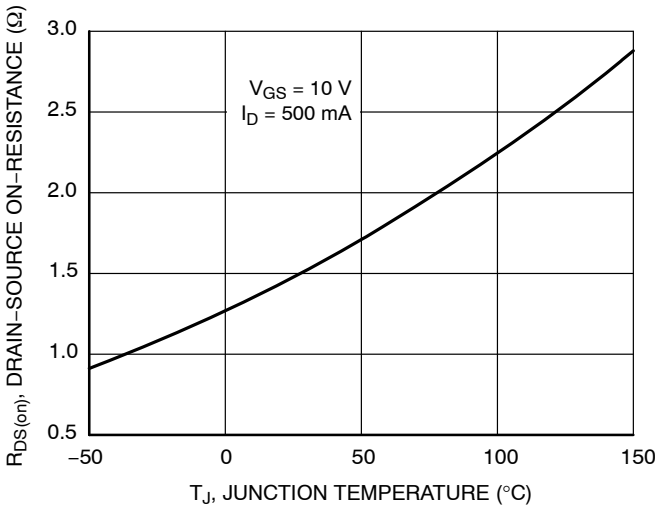


Figure 3. On-Resistance Variation with Temperature

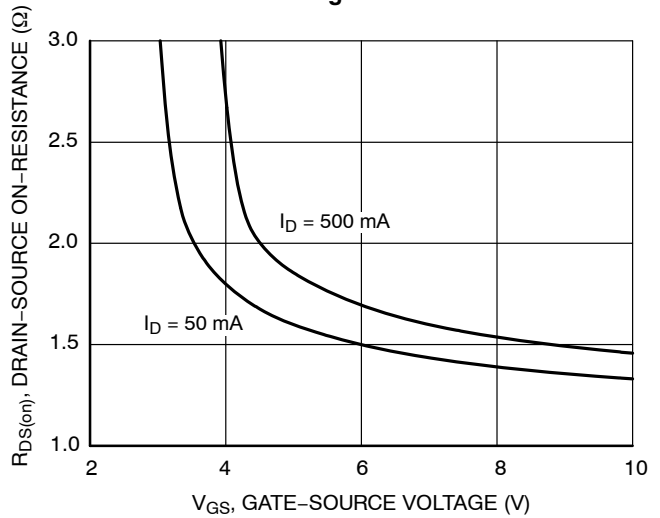


Figure 4. On-Resistance Variation with Gate-Source Voltage

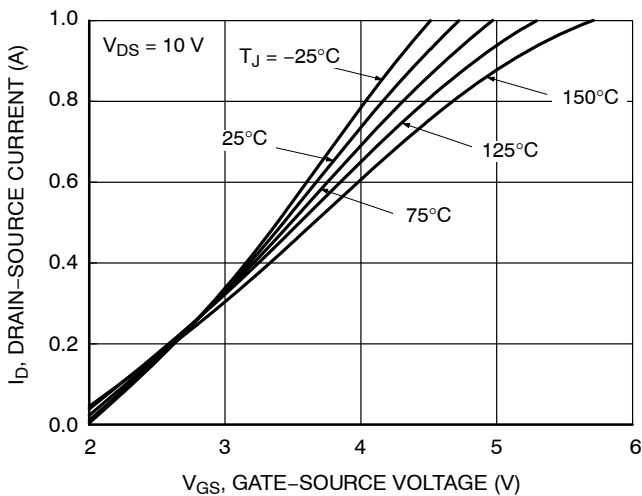


Figure 5. Transfer Characteristics

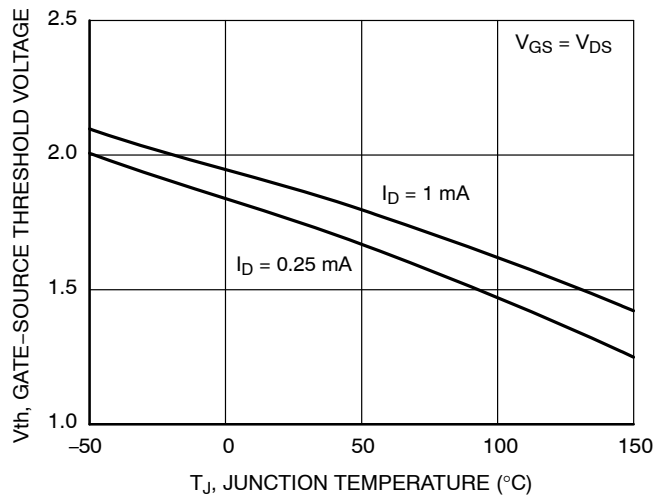
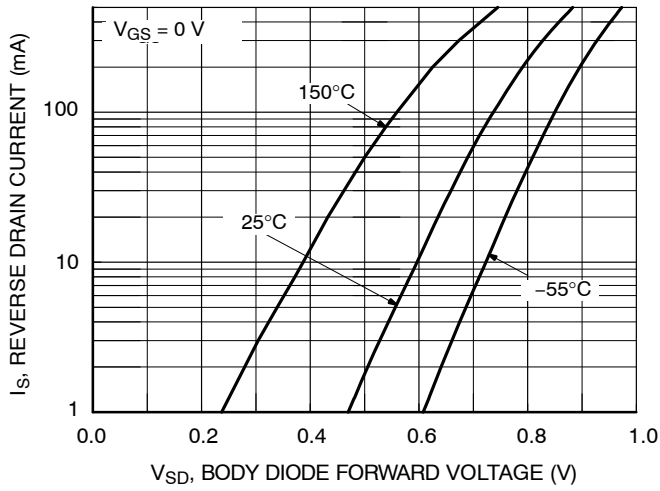


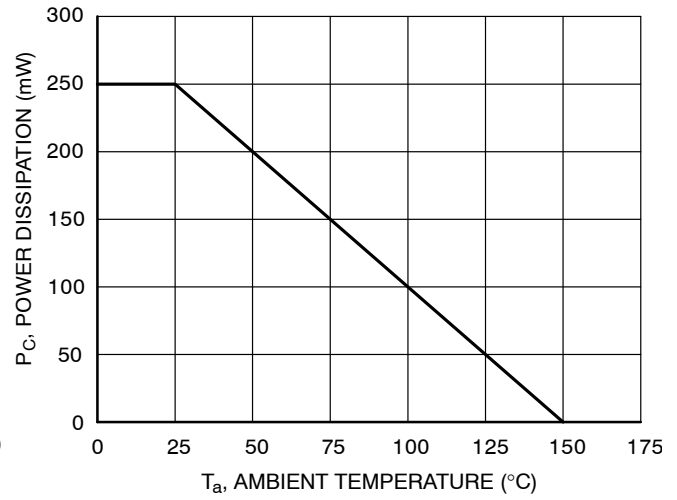
Figure 6. Gate Threshold Variation with Temperature

## 2N7002V/2N7002VA

### TYPICAL ELECTRICAL CHARACTERISTICS (continued)



**Figure 7. Reverse Drain Current Variation with Diode Forward Voltage and Temperature**



**Figure 8. Power Derating**

#### PACKAGE MARKING AND ORDERING INFORMATION

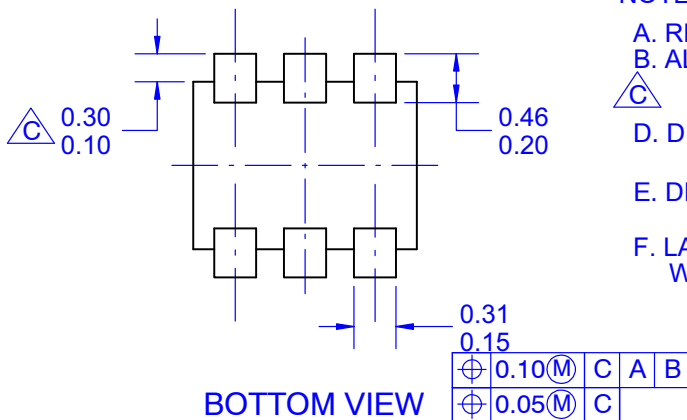
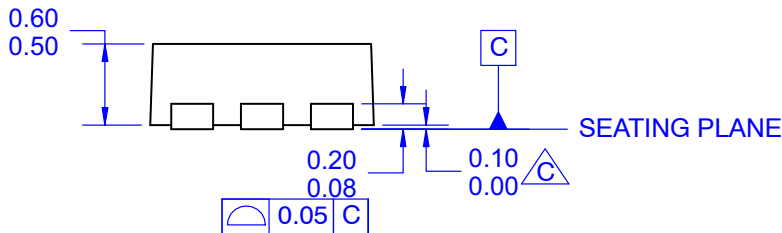
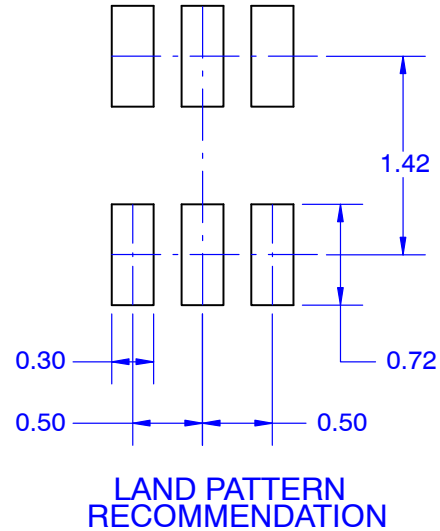
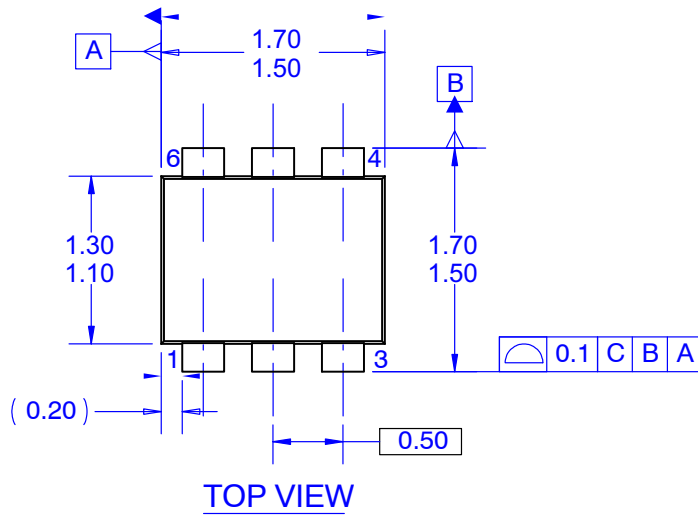
Device	Device Marking	Package	Shipping <sup>†</sup>
2N7002V	AB	SOT-563 (Pb-Free)	3000 / Tape & Reel
2N7002VA	AC	SOT-563 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).



**SOT-563**  
CASE 419BH  
ISSUE O

DATE 31 AUG 2016



NOTES: UNLESS OTHERWISE SPECIFIED.

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- B. ALL DIMENSIONS ARE IN MILLIMETERS.
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- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSION.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- F. LANDPATTERN RECOMMENDATION GENERATED WITH IPC LANDPATTERN GENERATOR

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